



# Functional properties of nanocrystalline, submicrocrystalline and polygonized Ti–Ni alloys processed by cold rolling and post-deformation annealing

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## ABSTRACT

Thermomechanical processing consisting of cold rolling ( $\epsilon = 0.3$ – $2.0$ ) and post-deformation annealing ( $300$ – $450$  °C, 1 h) was applied to binary Ti–Ni alloys to produce nanocrystalline structures (NS) or polygonized dislocation substructures (PDS), or their mixture. The evolution of the material structure and properties was studied using TEM, X-ray, microhardness, calorimetry and tensile testing techniques. Recovery stress and strain of the Ti–50.26 at.%Ni alloy and superelastic strain of the Ti–50.6 at.%Ni alloy were measured under static and fatigue conditions.

It was found that higher true yield stress of NS alloys not only increases the recovery stress potential, but, since it is combined with a relatively low transformation yield stress; it increases the completely recoverable strain. NS alloys generate recovery stresses that are twice as high as those of PDS alloys (1200 MPa), completely recoverable strains that are 10% greater (up to 6% in tension), and they demonstrate a higher cyclic stability of shape memory and superelastic properties. This improvement comes with the cost of a lower NS alloy fatigue damage tolerance, aggravated by the presence of microcracks caused by cold working. Binary Ti–Ni alloys, processed by annealing of an intermediately cold-worked ( $\epsilon = 0.75$ – $1$ ) alloy and containing mixed nanocrystalline structure and polygonized dislocation substructure, allow a high fatigue life combined with relatively high and cyclically stable functional properties.

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## 1. Introduction

The vast majority of bulk metallic materials including Ti–Ni shape memory alloys (SMA) with conventional coarse-grained structure can be severely deformed at low temperatures to refine their microstructure and produce ultrafine-grained and even partially amorphized materials [1,2].

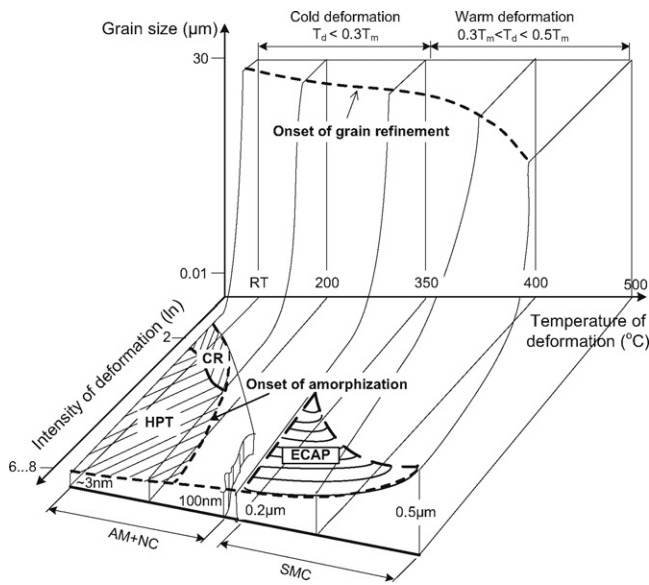
Such structural refinement allows significant improvement of mechanical and functional properties of metals and metallic alloys, more specifically in the case of reaching the nanometric range of structural elements (nanocrystalline materials  $NC \leq 100$  nm). From an engineering application perspective, ultrafine-grained are characterized by high yield, fracture and wear resistance, compared to conventional coarse or fine-grained materials [3,4]. The major difficulty with applying the severe plastic deformation (SPD) technique is that it requires very high deformations (logarithmic strains from 2 to 5). This level of strain requires the use of the highly specialized

techniques such as high pressure torsion (HPT), multi-directional forging (MDF), or equal-channel angular pressing (ECAP) [1–7].

In the strain intensity-deformation temperature-grain size space of Fig. 1, the grain-refinement potential of HPT and ECAP techniques, when they are applied to Ti–Ni shape memory alloys, is graphically illustrated. HPT-processing below  $300$  °C (true deformation strain  $\epsilon$  from 1.5 to 6...8) of Ti–Ni alloys results in a mixed amorphous–nanocrystalline structure (AM + NC) [8]. Homogeneous nanostructure can then be created using post-deformation annealing in the  $350$ – $450$  °C temperature range. However, HPT is appropriate for exclusively fundamental investigations, being limited to an individual processing of thin disk-shape specimens with 3–10 mm (maximum 20 mm) of diameter. ECAP is much more efficient than HPT from both the productivity and product size points of view. However, ECAP technology in its actual state does not allow creating true nanostructured Ti–Ni alloys. Given low deformability of these alloys, the lowest possible ECAP deformation temperature corresponds to  $350$  °C, which results in ECAP-formation of submicrocrystalline structure (SMC) (grain size  $> 100$ – $200$  nm)—instead of true nanostructure. Even though such a microstructure leads to a significant improvement of the Ti–Ni SMA functional properties [9,10], the entire potential of their structural refinement remains unemployed.

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**Fig. 1.** SPD techniques grain-refinement potential in the strain intensity–deformation temperature–grain size space (Ti–Ni shape memory alloys).

Cold rolling (CR) is thus reasonably considered as a valuable alternative to HPT and ECAP techniques because it can be used to tailor specific microstructures in Ti–Ni shape memory alloys, ranging from a dislocation-hardened substructure to ultrafine-grained and partially amorphized structures, when cold-work strain increases from moderate (true strain  $\epsilon = 0.3$ – $0.5$ ) to severe ( $\epsilon = 1.5$ – $2$ ) [11,12]. A mixed amorphous–nanocrystalline structure (AM+NC) issued from severe CR processing can be transformed into a nanocrystalline structure, after an appropriate post-deformation annealing (PDA) [13]. It has been shown that nanostructured Ti–50 at.%Ni alloy with 50–100 nm grain size confers significantly higher maximum recovery stress and maximum completely recoverable strain than a polygonized substructure with the same subgrain size [14–18]. The improvement of both the completeness of shape recovery and the recovery stress generation is attributed to the combination of a high true yield stress and a low transformation onset stress due to the particular dislocation-free nanocrystalline structure created by CR + PDA processing.

**Table 1**

Temperatures of the direct (reverse) martensitic transformation: (A) Ti–50.26 at.%Ni and (B) Ti–50.6 at.%Ni.

$e$	$T_{\text{PDA}}$	Direct transformation				Reverse transformation	
		Degrees Celsius					
		$M_{\text{f}}$	$M_{\text{s}}$	$R_{\text{f}}$	$R_{\text{s}}$	$A_{\text{s}}$	$A_{\text{f}}$
<b>(A) Ti–50.26 at.%Ni</b>							
Quenched	400	44	57	N/A	N/A	76	93
0.25		–10	Cannot be separated		59	55	86
0.75		Thermally induced	48	59	55	81	
1		martensitic transformation	50	59	43	73	
1.5		cannot be observed down	49	59	38	68	
2		to –150 °C	49	59	38	65	
$e$	$T_{\text{PDA}}$	Direct transformation				Reverse transformation	
		Degrees Celsius					
		$M_{\text{f}}$	$M_{\text{s}}$	$R_{\text{f}}$	$R_{\text{s}}$	$A_{\text{s}}$	$A_{\text{f}}$
<b>(B) Ti–50.6 at.%Ni</b>							
Quenched	400	–6	4	N/A	N/A	21	37
0.25		Thermally induced	40	59	45	60	
0.75		martensitic transformation	41	62	43	63	
1		cannot be observed down	42	63	45	65	
1.4		to –150 °C	48	63	46	64	

Recent work has shown that severe cold rolling conditions should be optimized because there is an increased risk of the appearance of rolling-related defects such as surface and edge cracks [17]. This is a classical trade-off situation: the higher the cold rolling intensity, the finer the material structure and the higher the functional properties of Ti–Ni SMA, but this improvement is reached in tandem with a greater the risk of microcrack appearance and therefore, a lower fatigue resistance [18]. This article focuses on the advantages and limitations of the CR-PDA technique, applied to binary Ti–Ni SMA, by comparing their single cycle and multiple cycle shape memory and superelastic properties.

## 2. Methodology

Two binary Ti–Ni shape memory alloys in the form of  $\varnothing 1$  mm wire (Special Metals Corp., NY, USA): high-temperature Ti–50.26 at.%Ni alloy for actuator applications and low-temperature Ti–50.6 at.%Ni alloy for superelastic applications, were subjected to 1–6 passes of cold rolling: logarithmic thickness reduction:  $\epsilon = 0.3$  to  $\epsilon = 2.0$  (Ti–50.26 at.%Ni) and  $\epsilon = 0.3$  to  $\epsilon = 1.4$  (Ti–50.6 at.%Ni). Rolling was conducted with a constant speed of 30 mm/s using a FENN four-high laboratory rolling mill (5.6 kW DC motor) with pulling tension set at 10% of the true yield stress. The cold-rolled strips were then annealed at  $T_{PDA} = 350, 400$  and  $450$  °C (1 h), where  $T_{PDA} = 400$  °C was selected as the reference annealing temperature because it corresponds to the best suited annealing temperature from the functional properties perspective [15].

The structure and substructure evolution was studied using a Tesla BS-540 transmission electron microscope. Thin foils were prepared using the “window” technique and electrolytic polishing in an  $\text{HClO}_4 + \text{CH}_3\text{COOH}$  solution. Characteristic temperatures were measured with heating–cooling rate of  $10$  °C/min using a PerkinElmer Pyris 1 DSC (see Table 1).

Note that for all the cold-rolled samples,  $M_s$  and  $M_f$  temperatures cannot be measured using DSC technique (see Table 1 and Fig. 2).  $M_s$  can however be determined by performing a series of isothermal tensile tests at different temperatures (not shown in this work), where the testing temperature corresponding to the lowest martensite variant reorientation stress is considered as a real  $M_s$  temperature. For all before mentioned thermomechanical processing cases,  $M_s$  temperature was in the vicinity of room temperature (RT).

Mechanical characterization of both Ti–50.26 and Ti–50.6 at.%Ni alloys was carried out using microhardness (Instron Tukon, 500 g) and tensile testing (Enduratec ELF 3200 and MiniBionix MTS) techniques.

### 2.1. Testing of Ti–50.26 at.%Ni alloy as actuator material

To characterize Ti–50.26Ni alloy performances as actuator material, corresponding samples were subjected to thermomechanical cycling under three tension testing modes (Fig. 3): (a) stress free recovery mode; (b) constant strain – or fixed support – recovery mode and (c) constant stress – or two-way stress-assisted – recovery mode. The direct Joule heating of the samples was performed using a Sorensen DLM 40-15 power supply, and the temperature was measured using a type-K thermocouple. Stress-free recovery cycling was performed

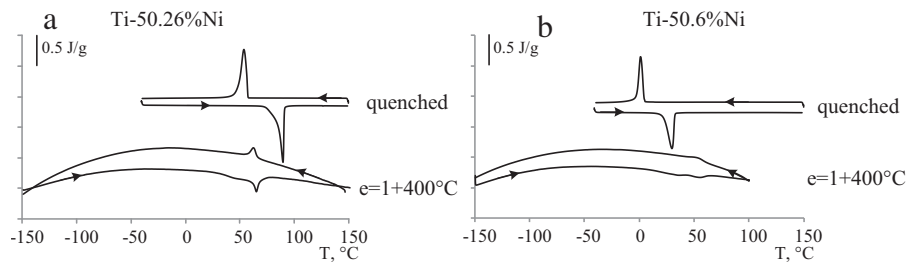


Fig. 2. DSC plots of (a) Ti-50.26 at.%Ni and (b) Ti-50.6 at.%Ni alloys.

with an Enduratec ELF 3200 testing machine using WINTEST software for simultaneous recording of force, displacement and temperature. Constant-strain and constant-stress cycling experiments were carried out on a custom-made test bench, equipped with a LabView acquisition system, using either rigid fixation of the samples' extremities, or calibrated payload [18]. During constant-strain recovery cycling, the acquisition system allowed simultaneous recording of the force and temperature data, whereas during constant-stress cycling, the acquisition system allowed simultaneous recording of displacement and temperature data:

**A. Stress-free recovery mode:** An SMA specimen was first deformed at RT then released to allow an elastic springback with a martensitic strain  $\varepsilon_M$  (O–A–B–C, Fig. 3⊕, a). The SMA specimen was then heated up to  $T > A_f$  to transform the material from martensite to austenite and to regain its undeformed length (C–D). The

SMA's martensitic ( $\varepsilon_M$ ), austenitic ( $\varepsilon_A$ ) and recovery ( $\varepsilon_r = \varepsilon_M - \varepsilon_A$ ) strains were extracted. The cycle was repeated up to failure or run-out at  $10^4$  cycles. The test was interrupted if the value of the austenitic strain ( $\varepsilon_A$ ) is close to that of the initial martensitic strain ( $\varepsilon_M$ ). The results obtained are reported in Fig. 9a–c.

**B. Fixed-support recovery mode:** An SMA specimen was deformed at RT, then released to allow an elastic springback, secured at its extremities at an initial martensitic strain  $\varepsilon_M$  (O–A–B–C) and heated up to  $T > A_f(\sigma)$  (C–E), where  $A_f(\sigma)$  is the final temperature of the reverse martensitic transformation under stress (Fig. 3⊕, b). The recovery stress generated upon heating is defined as  $\sigma_r = \sigma_A - \sigma_M$ , where  $\sigma_A$  are austenitic and  $\sigma_M$  martensitic stresses, respectively. The constraint specimen was thermally cycled between room temperature and an imposed heating temperature, up to specimen failure or test run-out at  $22 \times 10^3$  cycles. For each test, to obtain different recovery stresses, the heating temperature was varied between 70 and 250 °C. The results obtained are reported in Fig. 9d–f.

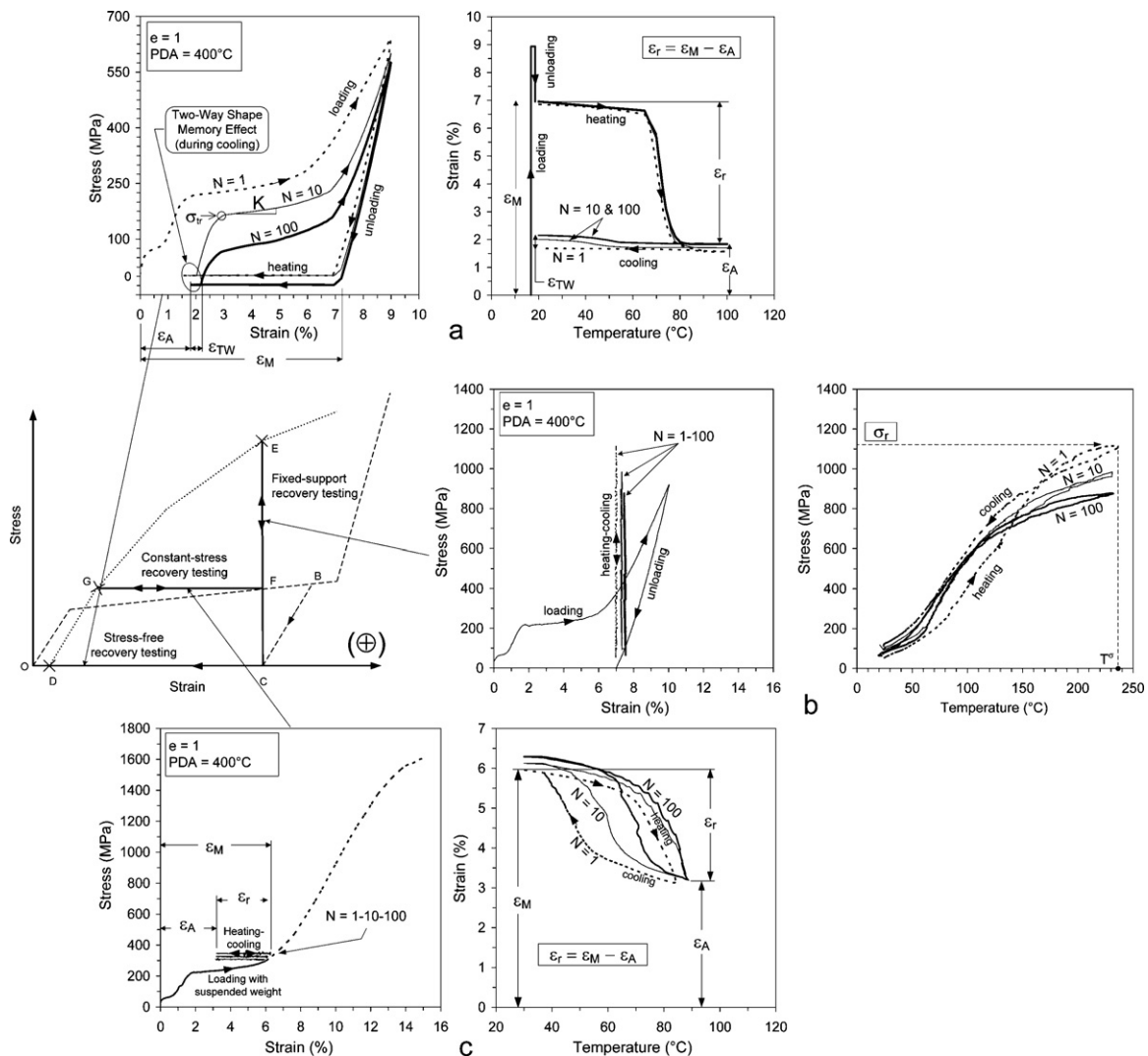
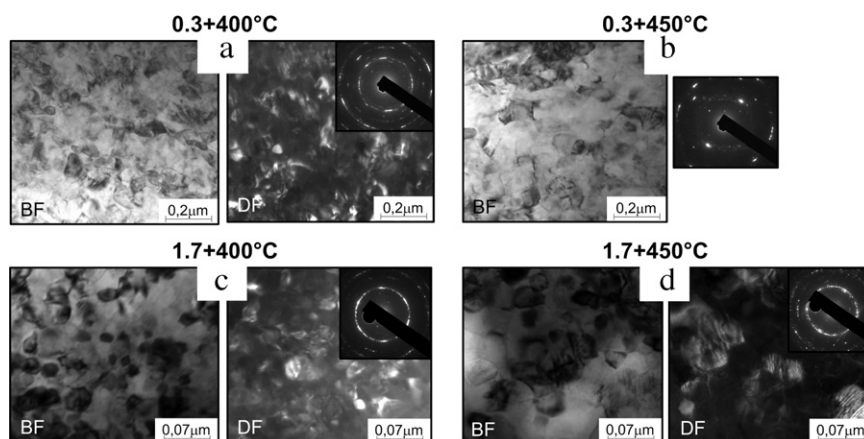


Fig. 3. Schematics of the strain–stress space (⊕) and typical stress–strain, strain–temperature and stress–temperature diagrams for (a) stress-free recovery, (b) fixed-support recovery and (c) constant-stress recovery testing modes (Ti-50.26 at.%Ni).





**Fig. 6.** Transmission electron microscopy (BF: bright-field; DF: dark-field) of Ti–50.7 at.%Ni alloy subjected to cold rolling  $e = 0.3$  (a and b) and 1.7 (c and d) and post-deformation annealing at 400 °C (a and b) and 450 °C (c and d). Electron diffraction patterns are inserted [16].

cant increase in dislocation density). Subgrains of 15–100 nm are observed in the dark-field image (Fig. 5a). This is a polygonized dislocation substructure.

After ( $e = 0.75 + T_{\text{PDA}} = 400$  °C), mixed submicrocrystalline polygonized structures and nanocrystalline structures are observed: in the dark-field image, the areas containing individual nanocrystals alternate with submicro-sized conglomerates of submicrograins. Asimuthal broadening of the diffraction spots becomes more pronounced than after initial  $e = 0.3$ , thus reflecting a greater crystallographic misorientation of substructural elements across the selected area (Fig. 5b).

After ( $e = 1.5 + T_{\text{PDA}} = 400$  °C), the structure contains evenly distributed austenite nanograins with dimensions varying from 30 to 60 nm and a small quantity of polygonized substructure, the latter witnessed by the presence of subgrains similar to those located in the middle of Fig. 5c bright-field image. On the dark-field image, a certain number of distinct grains can clearly be seen. Diffraction rings in this case contain overlapping but distinct spots from different grains of the structure and strongly azimuthally and radially broadened diffraction spots superposed from misoriented subgrains of the polygonized substructure (Fig. 5c).

After ( $e = 1.9 + T_{\text{PDA}} = 400$  °C), the structure is almost completely nanocrystalline. Radial broadening of the diffraction spots becomes less pronounced, thus reflecting lesser dislocation density in the material and therefore a decreasing quantity of the polygonized

substructure in favour of a larger quantity of the nanocrystalline structure (Fig. 5d).

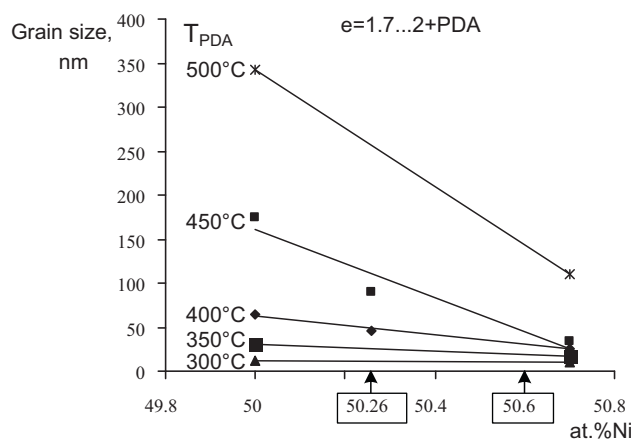
Note that the same microstructural changes was observed in nickel-rich Ti–50.7 at.%Ni alloy (see Fig. 6), but, given the higher precipitation activity in this nickel-rich compound, thermally activated processes such as static recovery, polygonization (in moderately deformed alloy), or crystallization and grain growth (in severely deformed alloy), were shifted to higher annealing temperatures [16]. In Fig. 7, it is shown that an increase in nickel concentration results in a decrease in grain size. The compositions of both alloys studied in this work are indicated by arrows.

### 3.2. Mechanical properties

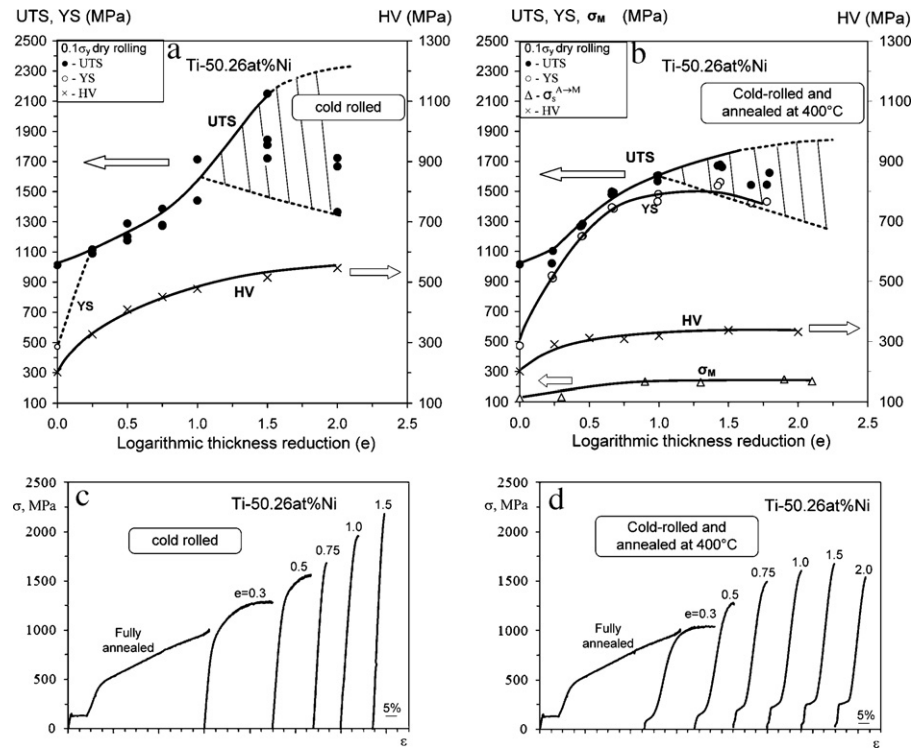
The evolution of the RT-tested mechanical properties of Ti–50.26 at.%Ni alloy in respect to the logarithmic thickness reduction is presented for the cold-rolled material in Fig. 8a, and for the cold-rolled and annealed material ( $T_{\text{PDA}} = 400$  °C, 1 h) in Fig. 8b. In the first case, stress-induced martensitic transformation cannot be observed, and the stress–strain curves are similar to those of common low-ductility alloys (Fig. 8c). In the second case, the onset stress for the martensite reorientation  $\sigma_M$ , yield stress (YS) and ultimate tensile stress (UTS) can be measured (Fig. 8d). It can be observed that the higher the logarithmic thickness reduction, the higher all the mechanical characteristics, but the increase in YS is more significant than that of  $\sigma_M$ , which forecasts improving functional properties of the alloy. However, an important scatter in tensile characteristics is observed for logarithmic thickness reductions exceeding  $e = 1.2$  (70%), related to the increased level of the cold-work and the corresponding higher probability of micro-cracking [17]. The latter phenomenon considerably risks impairing the fatigue properties of the alloys. Note that similar evolution of mechanical properties as a function of CR-PDA processing can be observed for Ti–50.6 at.%Ni alloy (not shown in this paper).

### 3.3. Ti–50.26 at.%Ni alloy as actuator material

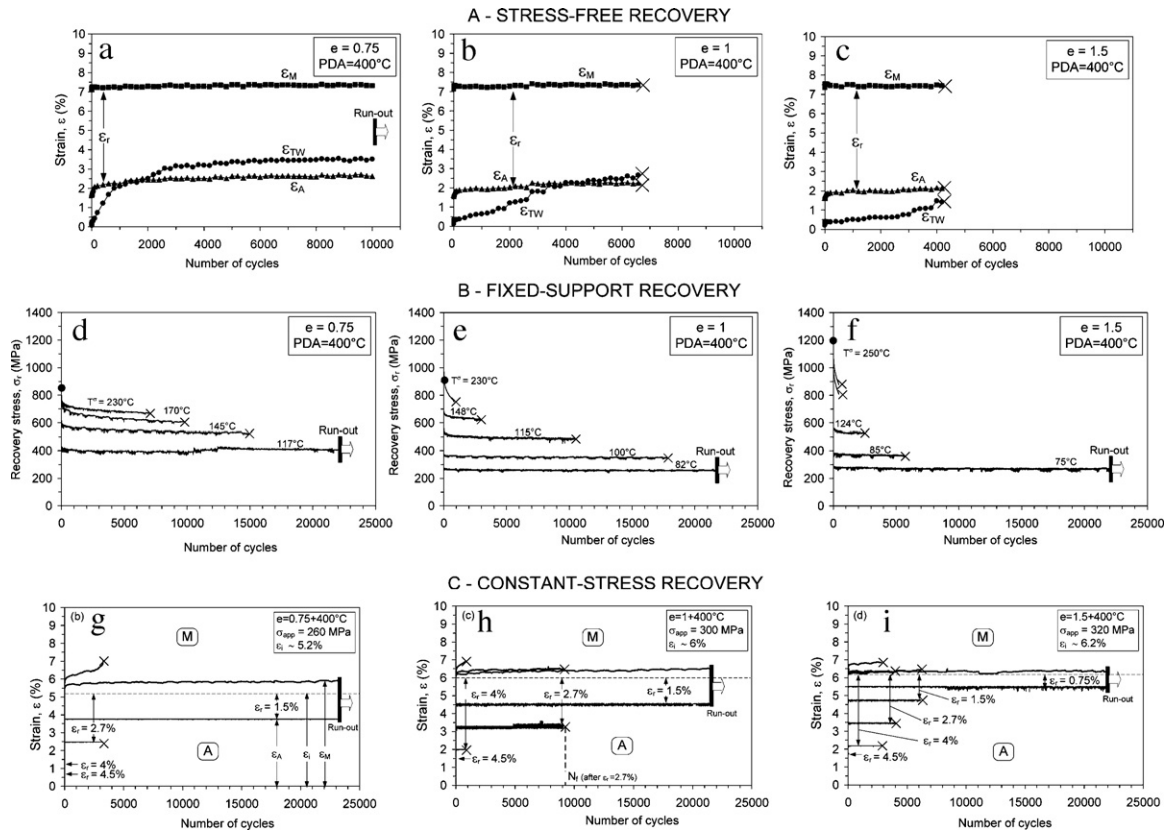
Typical testing curves are presented in Fig. 9a–i for the stress-free, fixed-support and constant-stress recovery modes for  $e = 0.75$ , 1 and 1.5 cold work intensities and post-deformation annealing at 400 °C, 1 h. Note that the plots obtained after the reference processing ( $e = 0$  plus quenching from 700 °C) and after moderate cold work ( $e = 0.3$ ) are not presented here, because they correspond to significantly lower functional properties [17]. In every case, when thermomechanical cycling is repeated, an evolution of the material behavior is observed:



**Fig. 7.** Grain size as a function of the nickel concentration after severe cold rolling and post-deformation annealing (data for Ti–50 and Ti–50.7 at.%Ni alloys are taken from [16]). Arrows indicate compositions of the alloys studied in this work.



**Fig. 8.** Mechanical properties (a and b) and deformation diagrams (c and d) as a function of the cold-work intensity for the (a and c) cold-rolled and (b and d) cold-rolled and annealed Ti-50.26 at.%Ni alloy.



**Fig. 9.** Ti-50.26 at.%Ni alloy: stress-free recovery (a–c); fixed-support recovery (d–f); constant-stress recovery (g–i); e = 0.75 (a), (d), (g), e = 1 (b), (e) and (h); e = 1.5 (c), (f) and (i) (adapted from [18]).

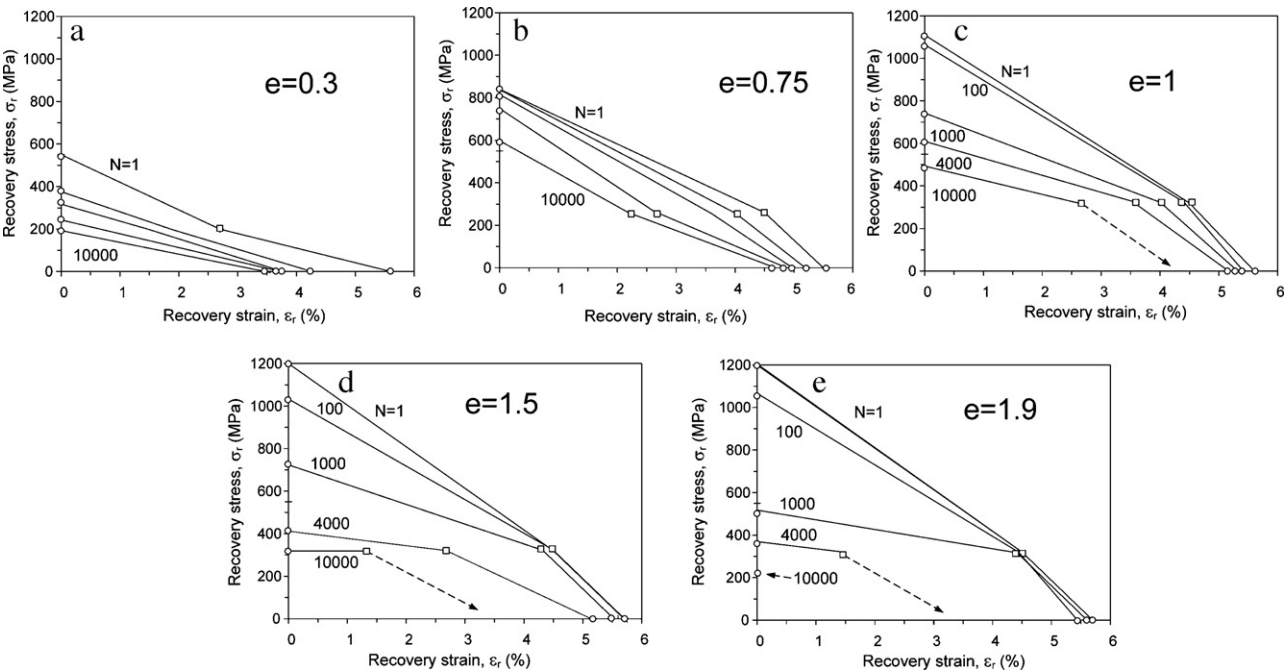


Fig. 10. Combined recovery stress–strain diagrams for different processing conditions of Ti–50.26 at.%Ni alloy:  $e = 0.3$  (a),  $0.75$  (b),  $1.0$  (c),  $1.5$  (d), and  $1.9$  (e).

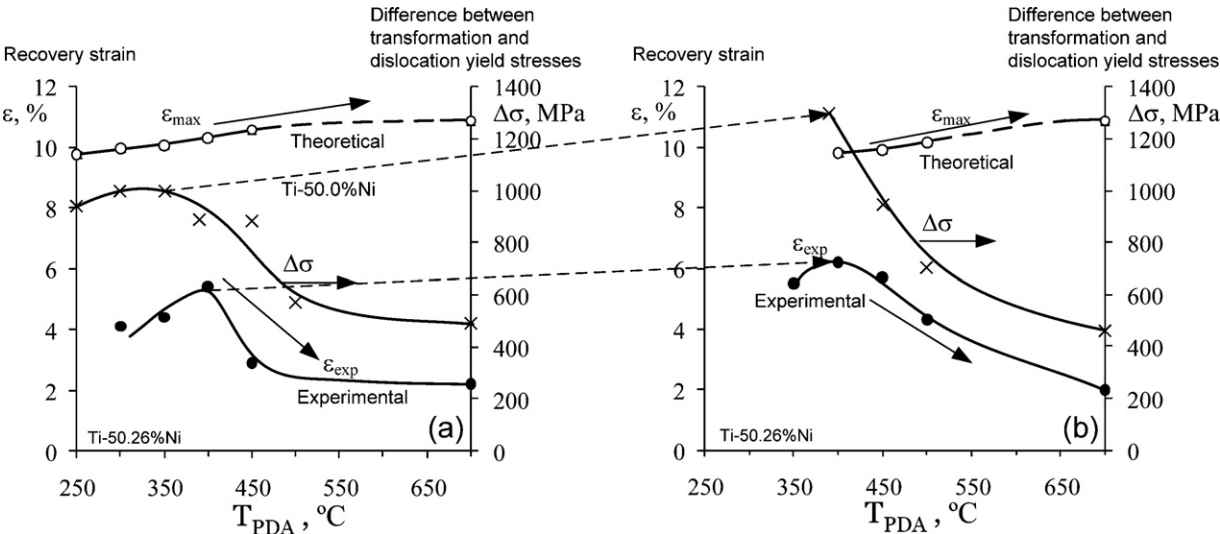
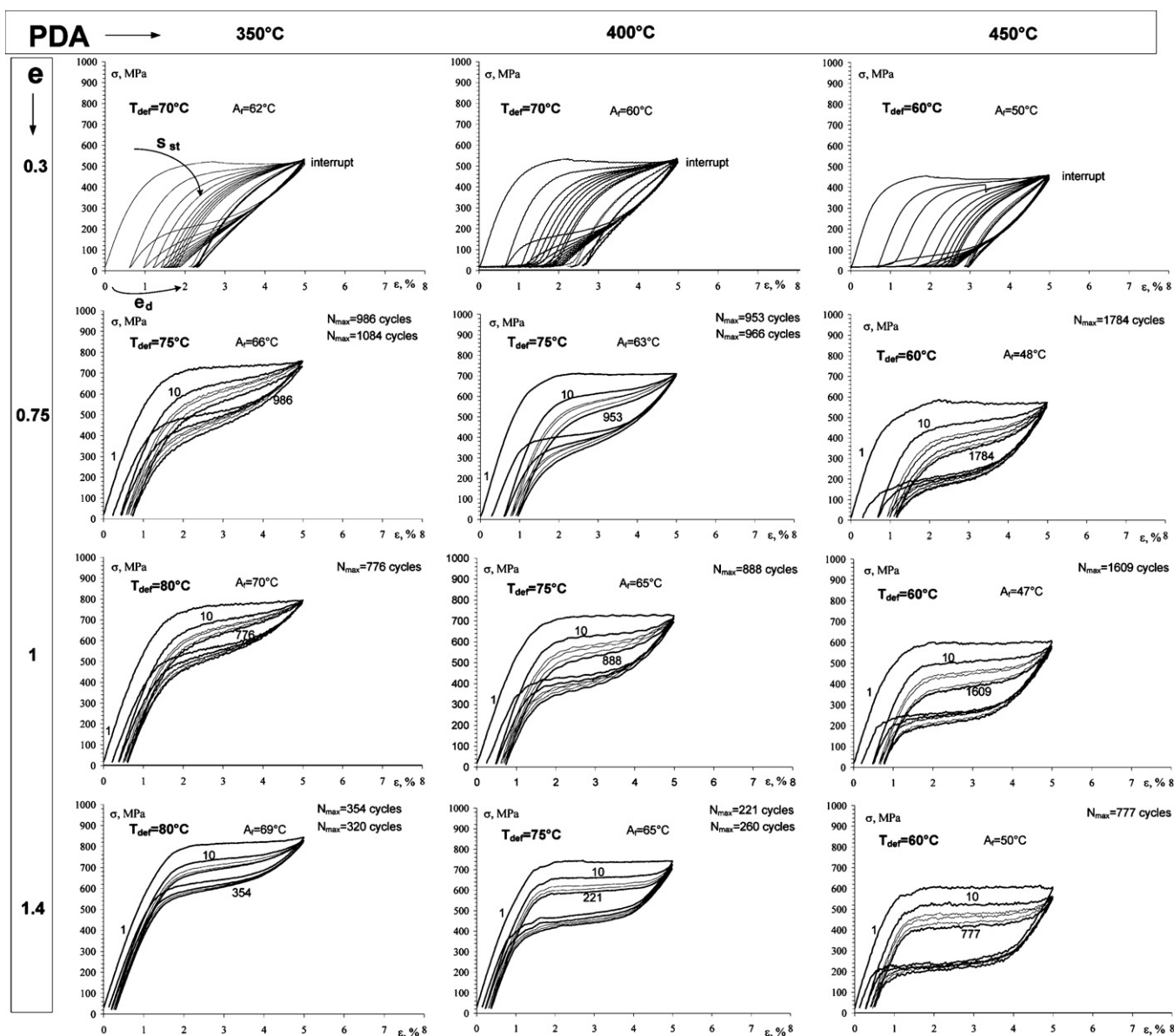


Fig. 11. Maximum recoverable strain (theoretical for polycrystalline non-textured material [20] and experimental—this work) and difference between transformation and true yield stresses versus PDA temperature for (a) polygonized ( $e = 0.3$ ) and (b) nanocrystalline ( $e = 2.0$ ) Ti–50.26 at.%Ni alloy.

- A. *Stress-free recovery*: The higher the cold work intensity, the greater the stability of the strain recovery behavior, but this positive effect is reached at the expense of a decrease in the specimens' life (Fig. 9a–c).
- B. *Fixed-support recovery*: The higher the cold work intensity, the higher the maximum recovery stress generated during the 1st heating–cooling cycle, but this gain rapidly attenuates as the number of the stress recovery cycles increases. Furthermore, the

Table 2  
Results of single and multiple-cycle testing of Ti–50.26 at.%Ni alloy as actuator material.

Cold work strain	Single-cycle testing		Multiple-cycle testing (fatigue)					
	Recovery stress (MPa)	Recovery strain (%)	Stress-free recovery		Fixed-support recovery		Constant-stress recovery	
			Recovery strain (%)	N before failure	Run-out stress (MPa)	N run-out ( $10^3$ cycles)	Work/cycle ( $\text{MJ}/\text{m}^3$ )	Total work ( $\text{GJ}/\text{m}^3$ )
0.3	560	4	4	Rut-out at 10,000	195	22	6	11
0.75	850	5.3	4.5	Rut-out at 10,000	400	22	10	128
1.0	1100	5.5	5	6500	270	22	13	120
1.5	1250	5.9	5.4	4000	280	22	14	75
1.9	1400	6	5.8	1200	250	22	15	25



**Fig. 12.** Superelastic curves of Ti-50.6 at.%Ni alloy for  $e = 0.3, 0.75, 1$  and  $1.4$  (rows) and  $T_{PDA} = 350, 400, 450$  °C (columns). Arrows on the  $e = 0.3, T_{PDA} = 350$  °C diagram indicate increase in number of cycles.

higher the cold work intensity, the lower the recovery stress that can be sustained for the run-out number of thermomechanical cycles  $N = 22 \times 10^3$  (Fig. 9d–f).

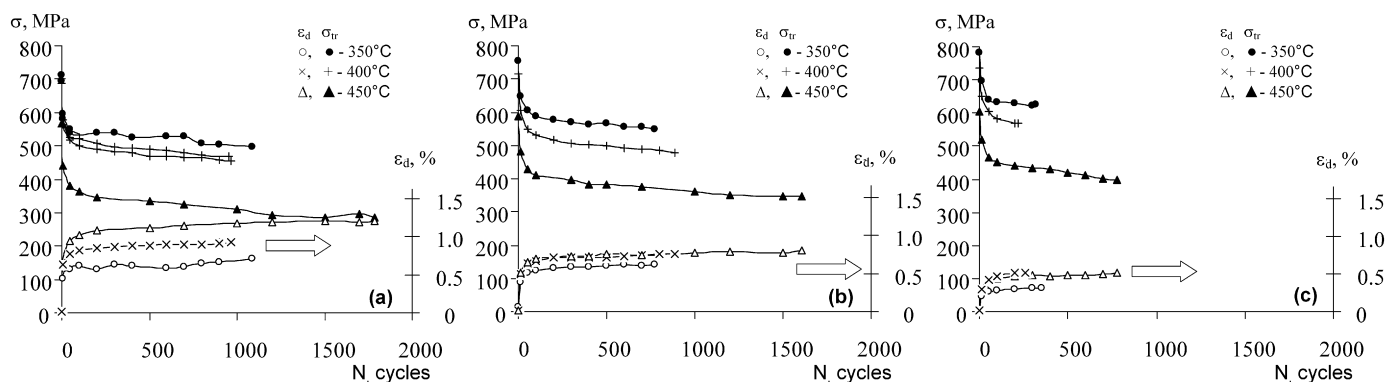
**C. Constant-stress recovery:** During constant-stress recovery testing, contrary to two previous testing modes, recovery forces and displacement are generated simultaneously, and their product corresponds to the mechanical work produced by an SMA element during cycling. Higher cold work intensity corresponds to greater alloy stability and higher stresses generated for the same level of recovery strains, which result in more mechanical work produced during one heating–cooling cycle. This positive effect is, however, counterweighted by a shorter fatigue life and, therefore, by a smaller total amount of mechanical work produced by the specimen till failure (Fig. 9g–i).

In Fig. 10 and in Table 2, the results obtained for all of the cold work conditions ( $e = 0.3, 0.75, 1.0, 1.5$  and  $1.9$ ) are collected for comparison purposes. The results from the stress-free recovery mode are plotted on the abscissa of the combined recovery stress–strain diagram (Fig. 10,  $\varepsilon \neq 0, \sigma = 0$ ); those from the fixed-support recov-

ery mode, on the ordinate ( $\sigma \neq 0, \varepsilon = 0$ ), and the results from the constant-stress recovery mode are shown with the  $\sigma \neq 0, \varepsilon \neq 0$  coordinates.

It can be observed that the higher the cold-work intensity, the larger the recovery stress–strain envelopes corresponding to low-cycle fatigue life, but, as the number of cycles increases, this work generation potential shrinks faster than that corresponding to lower cold-work intensities; the best compromise being  $e = 1 + T_{PDA} = 400$  °C processing, which results in a mixed polygonized-nanocrystalline microstructure (Fig. 10). It should be noted that the working envelopes corresponding to severe cold working conditions could be significantly enlarged if the technological processing becomes more defect-free. To address this problem, the use of shape instead of flat cold rolling and the application of proper post-annealing finishing technologies such as mechanical polishing can be envisaged.

It is worth noting in Table 2, that the greater the CR intensity, the higher the recovery strain  $\varepsilon_r$ , even though the maximum transformation lattice strain in this situation decreases. Indeed, it is known that the maximum transformation lattice strain, which



**Fig. 13.** Direct transformation onset stresses and residual strains as functions of the number of cycles for Ti-50.6 at.%Ni alloy: (a)  $e = 0.75$ , (b)  $e = 1$ , and (c)  $e = 1.4$ .

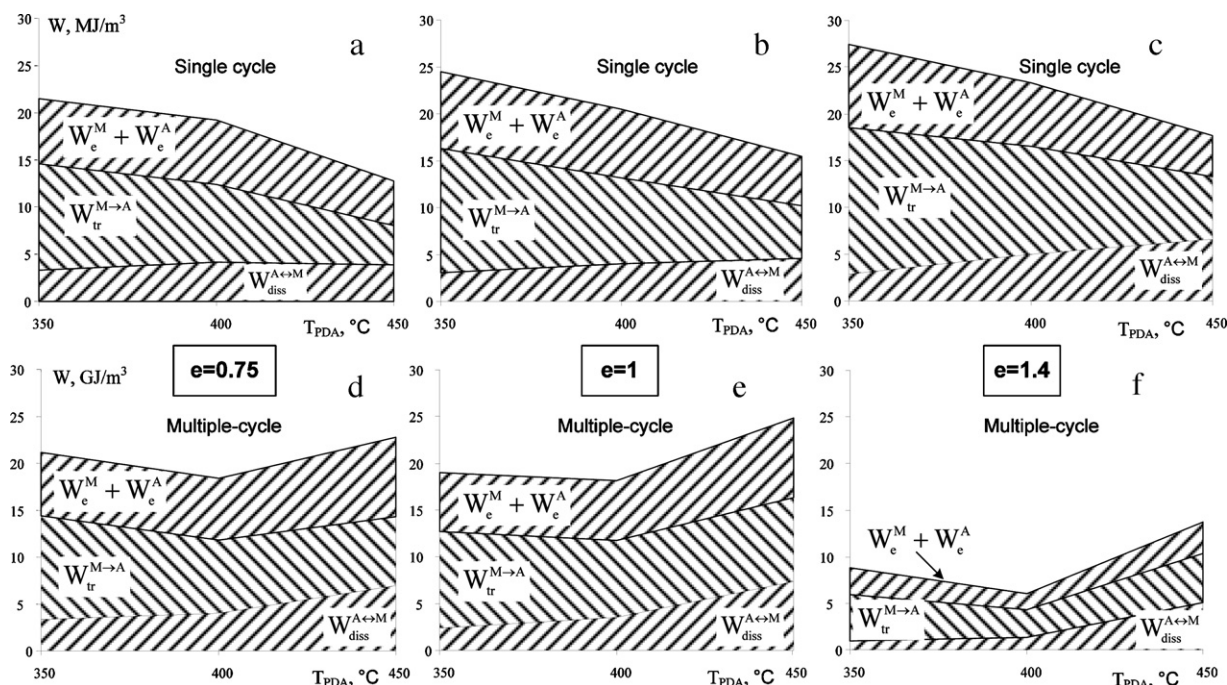
is a crystallographic resource of  $\varepsilon_r$ , reaches its maximum when the martensite forms from recrystallized austenite, and it lowers down when the martensite forms from thermomechanically processed austenite [19]. However, when comparing results on experimentally measured recovery strain to the difference ( $\Delta\sigma$ ) between the transformation and the dislocation (or true) yield stresses for polygonized substructure (Fig. 11a) and nanocrystalline structure (Fig. 11b), it can be observed that for both cases, the maxima in  $\varepsilon_r$  and  $\Delta\sigma$  coincide. Those maxima do not correspond to the maxima in the theoretical resources of the recovery strain. It confirms the fact that the lower the risk of triggering the plastic deformation mechanisms, the greater recovery strain can be obtained [20].

### 3.4. Ti-50.6 at.%Ni alloy as superelastic material

Superelastic curves obtained with Ti-50.6 at.%Ni alloy samples tested at  $A_f + 10^\circ\text{C}$  are presented in Fig. 12, and the onset stresses and residual strains are plotted as functions of the number of cycles in Fig. 13. It can be observed that the higher the cold work intensity and the lower the annealing temperature, the higher the

onset stresses of the direct martensitic transformation, which is well known [20]. As far as stability of the superelastic behavior is concerned, the higher the cold work intensity and the lower the annealing temperature, the lower the residual strain accumulation and the onset stress decrease with cycling, but this higher stability is reached at the expense of the specimen's cyclic life (Figs. 12 and 13). In contrast, with low-intensity cold work ( $e = 0.3$ ), the material degradation was so significant that testing had to be interrupted before failure occurred.

In Fig. 14, three mechanical energy components are plotted in respect to the thermomechanical processing conditions (see Fig. 4 for definition): energy corresponding mainly to the elastic recovery of the single martensite ( $W_e^M$ ) and austenite ( $W_e^A$ ) phases, transformation-related energy recovered ( $W_{tr}^{M \rightarrow A}$ ), and energy dissipated during superelastic loading and unloading ( $W_{diss}^{A \leftrightarrow M}$ ). Note that the sum of these components corresponds to the total mechanical energy accumulated in the material during superelastic loading ( $W_{tot}^{A \rightarrow M}$ ). These results are presented in Fig. 14a–c for single cycle testing (10th cycle is taken) and in Fig. 14d–f, for multiple cycle testing where the energy components are summarized for all the cycles before failure.



**Fig. 14.** (a–c) Energy components per cycle (cycle 10 is taken) and (d–f) energy components per lifespan as functions of the thermomechanical processing of Ti-50.6 at.%Ni alloy.

**Table 3**

Results of single and multiple-cycle testing of Ti–50.6 at.%Ni alloy as superelastic material.

$T_{\text{PDA}}$ (°C)	Single-cycle testing			Multiple-cycle testing (fatigue)											
	Accum. strain <sup>a</sup> (%)			Accum. strain <sup>a</sup> (%)			N before failure			Energy/cycle (MJ/m <sup>3</sup> ) Total energy (GJ/m <sup>3</sup> )			Energy restitution efficiency		
	350	400	450	350	400	450	350	400	450	350	400	450	350	400	450
Cold work strain															
0.3	0.7	0.75	0.8	2.2	2.7	3				Cycle interrupted before failure (significant accumulated strain)					
0.75	0.3	0.32	0.35	0.8	0.9	1.2	1000	960	1800	22/22	19.5/19	15/23	0.85	0.78	0.72
1.0	0.22	0.25	0.25	0.6	0.78	0.81	780	890	1600	25/19	20/18	17/25	0.88	0.81	0.71
1.4	0.1	0.15	0.15	0.3	0.4	0.5	350	240	780	27/8	24/7	19/14	0.90	0.78	0.63

<sup>a</sup> Total initial strain for the 1st cycle is 5%.

For the *single-cycle testing*, it can be observed that the higher the cold-work intensity and the lower the PDA temperature, the greater the overall mechanical energy involved in cycling, mostly because of the higher onset stresses in these cases. The quantity of dissipated energy appeared to be strongly affected by the annealing temperature – the higher the annealing temperature, the greater the dissipated energy – while being less significantly affected by the cold-work intensity. These phenomena result in the highest energy restitution efficiency for the case of  $e = 1.4 + T_{\text{PDA}} = 350^\circ\text{C}$  ( $\eta = 0.9$ , see Eq. (1) and Table 3).

In the case of *multiple-cycle testing*, however, the situation becomes inversed: the higher the cold-work intensity, the lower the overall mechanical energy accumulated and restituted during cycling, mostly due to the lower number of cycles associated with this processing. As for the influence of the annealing temperature, the situation becomes complex because the lowest mechanical energy corresponds to an intermediate  $400^\circ\text{C}$  and not to a lower  $350^\circ\text{C}$  annealing temperature. This intermediate temperature affects all of the cold-work intensities, reflecting the adverse influence of the intensive  $\text{Ti}_3\text{Ni}_4$  precipitation at  $400^\circ\text{C}$  on the fatigue resistance during superelastic cycling. The results obtained for single and multiple-cycle superelastic testing of Ti–50.6 at.%Ni alloy samples are collected in Table 3.

To summarize, it can be observed that the higher the cold-work intensity, the larger the energy accumulation/restitution potential of the alloy, but, as the number of cycles increases, this potential decreases faster than that corresponding to lower cold-work intensities; the best compromise being  $e = 0.75 \dots 1.0 + T_{\text{PDA}} = 400^\circ\text{C}$  processing, which results in a mixed polygonized-nanocrystalline microstructure.

#### 4. Conclusions

1. By increasing the cold rolling thickness reduction from  $e = 0.3$  to 1.9 (Ti–50.26 at.%Ni) and from  $e = 0.3$  to 1.4 (Ti–50.6 at.%Ni), it becomes possible – after post-deformation annealing at 350, 400,  $450^\circ\text{C}$  (1 h) – to regulate the material microstructure from a polygonized substructure to a nanocrystalline structure, passing through a mixed polygonized-nanocrystalline microstructure.
2. During single-cycle testing, shape memory (stress and strain generation) and superelastic (reversible deformation) properties reach their absolute maximum in alloys with nanocrystalline structure due to a unique combination of a high true yield stress and a low transformation onset stress in these materials.
3. During multiple-cycle testing, nanocrystalline alloys demonstrate higher cyclic stability in their functional properties

than mixed polygonized-nanocrystalline alloys, but lower fatigue resistance, mainly because of the cold-work induced defects.

4. If an application engineer requires alloys with the highest stress–strain recovery potential and functional stability, but only for a limited number of cycles, nanocrystalline alloys are the best solution. However, alloys with mixed polygonized-nanocrystalline microstructure ( $e = 0.75\text{--}1.0 + T_{\text{PDA}} = 400^\circ\text{C}$ ) represent an interesting compromise in terms of the best possible combination of functional performance, cyclic stability and fatigue resistance.

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